



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Atty. Docket No.: BU9-99-197

2823
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Response Transmittal

In re application of: Furukawa, et al.

Serial No.: 09/599,783 ✓

Filed: 6/22/00

For: METHOD FOR ETCHING A SEMICONDUCTOR
SUBSTRATE USING GERMANIUM HARD MASK

Box Fee

Commissioner of Patents and Trademarks
Washington, D.C. 20231

Sir:

Transmitted herewith for filing in the above-identified Application is a:

1. Response;
2. Letter to the Draftsperson including 2 sheets of drawings; and
3. Postcard.

☐ No additional fee is required.☒ The fee has been calculated as shown below:

(Col. 1)	(Col. 2)	(Col. 3)
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TOTAL 21	MINUS	20 = 1
INDEPENDENT 3	MINUS	3 = 0
<input type="checkbox"/> ONE MONTH EXTENSION OF TIME		

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I hereby certify that this paper is being facsimile transmitted to the Patent and Trademark Office on the date shown below.

☒ CERTIFICATE OF MAILING

I hereby certify that I am depositing the enclosed or attached correspondence with the United States Postal Service as first class mail in an envelope addressed to Box Fee, Commissioner of Patents and Trademarks, Washington, D.C. 20231,

on

May 31, 2001

Heather Clark

Name of person signing

Other Than Small Entity

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x \$18.00=	\$ 18.00
x \$80.00=	\$.00
\$110.00	\$.00
Total	\$ 18.00

☒ Please charge IBM Corporation Deposit Account No. 09-0456 in the amount of \$ 18.00. A duplicate copy of this sheet is enclosed.☒ The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to IBM Corporation Deposit Account No. 09-0456. A duplicate copy of this sheet is enclosed.☒ Any additional filing fees required under 37 C.F.R. §1.16.☒ Any patent application processing fees under 37 C.F.R. §1.17.

Date: May 31, 2001

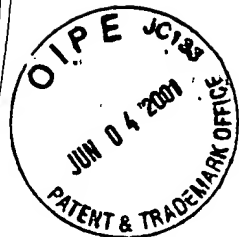
Respectfully submitted,

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Docket No. BU9-99-197

#5/Amend A
Atty
6/11/01

IN THE UNITED STATES PATENT AND
TRADEMARK OFFICE
AMENDMENT

Applicant:	Furukawa, et al.	Docket No.:	BU9-99-197
Serial No.:	09/599,783	Group Art Unit:	2823
Filed:	06/22/00	Examiner:	Eaton, K.
TITLE:	METHOD FOR ETCHING A SEMICONDUCTOR SUBSTRATE USING GERMANIUM HARD MASK		

Box Fee
The Commissioner of Patents and Trademarks
Washington, D.C. 20231

Sir:

Responsive to the office action dated March 26, 2001, Applicants amend the application as follows:

06/07/2001 HNDHAMM1 00000140 090456 09599783
01 FC:103 18.00 CH

I HEREBY CERTIFY THAT THE CORRESPONDENCE TO WHICH THIS STATEMENT IS AFFIXED IS BEING DEPOSITED WITH THE UNITED STATES POSTAL SERVICE, POSTAGE PAID, AS FIRST CLASS MAIL IN AN ENVELOPE ADDRESSED TO THE COMMISSIONER OF PATENTS AND TRADEMARKS, WASHINGTON, D.C., 20231, ON: May 31, 2001

SIGNED: Heather Clark